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INTEGRATED CIRCUITS

DATA SHEET

74ABT899

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

Product specification Supersedes data of 1993 Oct 04 IC23 Data Handbook





9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899

FEATURES

- Symmetrical (A and B bus functions are identical)
- Selectable generate parity or "feed-through" parity for A-to-B and B-to-A directions
- Independent transparent latches for A-to-B and B-to-A directions
- Selectable ODD/EVEN parity
- Continuously checks parity of both A bus and B bus latches as ERRA and ERRB
- Ability to simultaneously generate and check parity
- Can simultaneously read/latch A and B bus data
- Output capability: +64 mA/–32mA
- Latch-up protection exceeds 500mA per Jedec JC40.2 Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Power up 3-State
- Power-up reset
- Live insertion/extraction permitted

DESCRIPTION

The 74ABT899 is a 9-bit to 9-bit parity transceiver with separate transparent latches for the A bus and B bus. Either bus can generate or check parity. The parity bit can be fed-through with no change or the generated parity can be substituted with the SEL input.

Parity error checking of the A and B bus latches is continuously provided with ERRA and ERRB, even with both buses in 3-State.

The 74ABT899 features independent latch enables for the A and B bus latches, a select pin for ODD/EVEN parity, and separate error signal output pins for checking parity.

FUNCTIONAL DESCRIPTION

The 74ABT899 has three principal modes of operation which are outlined below. All modes apply to both the A-to-B and B-to-A directions.

Transparent latch, Generate parity, Check A and B bus parity: Bus A (B) communicates to Bus B (A), parity is generated and passed on to the B (A) Bus as BPAR (APAR). If LEA and LEB are High and the Mode Select (SEL) is Low, the parity generated from A0-A7 and B0-B7 can be checked and monitored by ERRA and ERRB. (Fault detection on both input and output buses.)

Transparent latch, Feed-through parity, Check A and B bus parity:

Bus A (B) communicates to Bus B (A) in a feed-through mode if SEL is High. Parity is still generated and checked as ERRA and ERRB and can be used as an interrupt to signal a data/parity bit error to the CPU.

Latched input, Generate/Feed-through parity, Check A (and B) bus parity:

Independent latch enables (LEA and LEB) allow other permutations of:

- Transparent latch / 1 bus latched / both buses latched
- Feed-through parity / generate parity
- Check in bus parity / check out bus parity / check in and out bus parity

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	$C_L = 50pF; V_{CC} = 5V$	2.9	ns
t _{PLH} t _{PHL}	Propagation delay An to ERRA	$C_L = 50pF; V_{CC} = 5V$	6.1	ns
C _{IN}	Input capacitance	$V_I = 0V$ or V_{CC}	4	рF
C _{I/O}	Output capacitance	Outputs disabled; $V_O = 0V$ or V_{CC}	7	рF
I _{CCZ}	Total supply current	Outputs disabled; V _{CC} =5.5V	50	μΑ

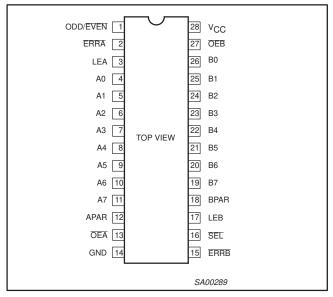
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
28-Pin Plastic PLCC	-40°C to +85°C	74ABT899 A	74ABT899 A	SOT261-3
28-Pin Plastic SOP	-40°C to +85°C	74ABT899 D	74ABT899 D	SOT136-1
28-Pin Plastic SSOP	-40°C to +85°C	74ABT899 DB	74ABT899 DB	SOT341-1

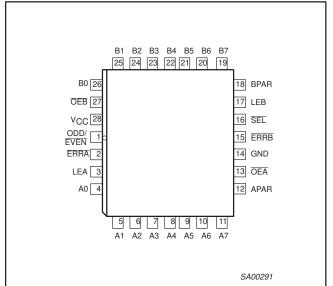
9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899

PIN CONFIGURATION



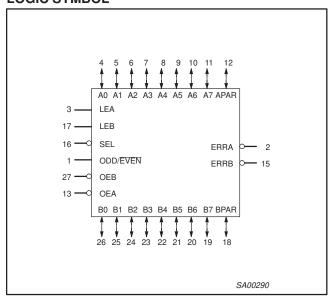
PLCC PIN CONFIGURATION



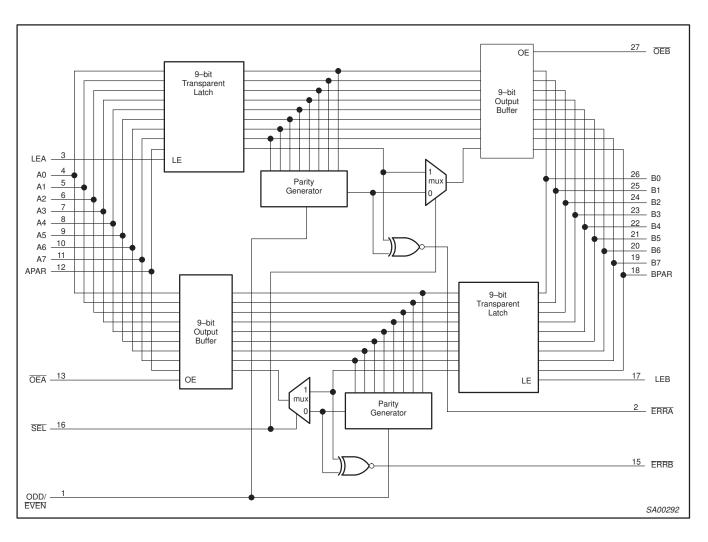
PIN DESCRIPTION

SYMBOL	PIN NUMBER	NAME AND FUNCTION					
A0 - A7	4, 5, 6, 7, 8, 9, 10, 11	Latched A bus 3-State inputs/outputs					
B0 - B7	19, 20, 21, 22, 23, 24, 25, 26	Latched B bus 3-State inputs/outputs					
APAR	12	A bus parity 3-State input					
BPAR	18	B bus parity 3-State input					
ODD/ EVEN	1	Parity select input (Low for EVEN parity)					
OEA, OEB	13, 27	Output enable inputs (gate A to B, B to A)					
SEL	16	Mode select input (Low for generate)					
LEA, LEB	3, 17	Latch enable inputs (transparent High)					
ERRA, ERRB 2, 15		Error signal outputs (active-Low)					
GND	14	Ground (0V)					
V _{CC}	28	Positive supply voltage					

LOGIC SYMBOL



74ABT899



FUNCTION TABLE

	I	NPUTS	;		OPERATING MODE						
OEB	OEA	SEL	LEA	LEB							
Н	Н	Х	Х	Х	3-State A bus and B bus (input A & B simultaneously)						
Н	L	L	L	Н	$B \rightarrow A$, transparent B latch, generate parity from B0 - B7, check B bus parity						
Н	L	L	Н	Н	$B \rightarrow A$, transparent A & B latch, generate parity from B0 - B7, check A & B bus parity						
Н	L	L	Х	L	$B \rightarrow A$, B bus latched, generate parity from latched B0 - B7 data, check B bus parity						
Н	L	Н	Х	Н	$B \to A,$ transparent B latch, parity feed-through, check B bus parity						
Н	L	Н	Н	Н	$B \rightarrow A$, transparent A & B latch, parity feed-through, check A & B bus parity						
L	Н	L	Н	Х	$A \rightarrow B$, transparent A latch, generate parity from A0 - A7, check A bus parity						
L	Н	L	Н	Н	$A \rightarrow B$, transparent A & B latch, generate parity from A0 - A7, check A & B bus parity						
L	Н	L	L	Х	$A \rightarrow B$, A bus latched, generate parity from latched A0 - A7 data, check A bus parity						
L	Н	Н	Н	L	$A \to B,$ transparent A latch, parity feed-through, check A bus parity						
L	Н	Н	Н	Н	$A \rightarrow B$, transparent A & B latch, parity feed-through, check A & B bus parity						
L L X X X					Output to A bus and B bus (NOT ALLOWED)						

H = High voltage level

L = Low voltage level

X = Don't care

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899

PARITY AND ERROR FUNCTION TABLE

	INPU ⁻	TS			OUTPUTS						
SEL	ODD/EVEN	xPAR (A or B)	Σ of High Inputs	xPAR (B or A)	ERRt	ERRr*		PARITY MODES			
Н	Н	Н	Even Odd	H H	H L	H L	Odd				
Н	Н	L	Even Odd	L L	L H	L H	Mode	Feed-through/check parity			
Н	L	Н	Even Odd	H	L H	L H	Even				
Н	L	L	Even Odd	LL	H L	H L	Mode				
L	Н	Н	Even Odd	H L	H L	H H	Odd				
L	Н	L	Even Odd	H	L H	H H	Mode	Generate parity			
L	L	Н	Even Odd	L H	L H	H H	Even				
L	L	L	Even Odd	L H	H L	H H	Mode				

H = High voltage level

Low voltage level

= Transmit—if the data path is from A→B then ERRt is ERRA = Receive—if the data path is from A→B then ERRr is ERRB Blocked if latch is not transparent

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
l _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V
l _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 1505C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

74ABT899

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	ITS	UNIT
		Min	Max	
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δν	Input transition rise or fall rate	0	5	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

						LIMITS			
SYMBOL	PARAM	ETER	TEST CONDITIONS	Tar	_{nb} = +25	°C	T _{amb} =	–40°C 35°C	UNIT
				Min	Тур	Max	Min	Max	
V _{IK}	Input clamp volt	age	V _{CC} = 4.5V; I _{IK} = -18mA		-0.9	-1.2		-1.2	V
			$V_{CC} = 4.5V$; $I_{OH} = -3mA$; $V_I = V_{IL}$ or V_{IH}	2.5	3.5		2.5		V
V _{OH}	High-level outpu	ıt voltage	$V_{CC} = 5.0V$; $I_{OH} = -3mA$; $V_I = V_{IL}$ or V_{IH}	3.0	4.0		3.0		V
			$V_{CC} = 4.5V$; $I_{OH} = -32mA$; $V_I = V_{IL}$ or V_{IH}	2.0	2.6		2.0		V
V _{OL}	Low-level outpu	t voltage	$V_{CC} = 4.5V$; $I_{OL} = 64mA$; $V_I = V_{IL}$ or V_{IH}		0.42	0.55		0.55	V
V _{RST}	Power-up outpu voltage ³	t low	$V_{CC} = 5.5V$; $I_O = 1mA$; $V_I = GND$ or V_{CC}		0.13	0.55		0.55	V
l _l	Input leakage Control pins		V _{CC} = 5.5V; V _I = GND or 5.5V		±0.01	±1.0		±1.0	μА
	current	Data pins	$V_{CC} = 5.5V; V_I = GND \text{ or } 5.5V$		±5	±100		±100	μΑ
I _{OFF}	Power-off leaka	ge current	$V_{CC} = 0.0V; V_O \text{ or } V_{1 \le} 4.5V$		±5.0	±100		±100	μА
I _{PU} /I _{PD}	Power-up/down output current ⁴	3-State	V_{CC} = 2.1V; V_{O} = 0.5V; V_{I} = GND or V_{CC} ; V_{OE} = Don't care		±5.0	±50		±50	μА
I _{IH} + I _{OZH}	3-State output H	ligh current	$V_{CC} = 5.5V; V_O = 2.7V; V_I = V_{IL} \text{ or } V_{IH}$		5.0	50		50	μА
I _{IL} + I _{OZL}	3-State output L	ow current	$V_{CC} = 5.5V; V_O = 0.5V; V_I = V_{IL} \text{ or } V_{IH}$		-5.0	-50		-50	μА
I _{CEX}	Output High lea	kage current	$V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GND \text{ or } V_{CC}$		5.0	50		50	μА
IO	Output current ¹		V _{CC} = 5.5V; V _O = 2.5V	- 50	-80	-180	-50	-180	mA
I _{CCH}			$V_{CC} = 5.5V$; Outputs High, $V_{I} = GND$ or V_{CC}		50	250		250	μА
I _{CCL}	Quiescent supply current		$V_{CC} = 5.5V$; Outputs Low, $V_I = GND$ or V_{CC}		28	34		34	mA
I _{CCZ}			V_{CC} = 5.5V; Outputs 3-State; V_{I} = GND or V_{CC}		50	250		250	μА
Δl _{CC}	Additional supplinput pin ²	y current per	V_{CC} = 5.5V; one input at 3.4V, other inputs at V_{CC} or GND		0.3	1.5		1.5	mA

NOTES:

- 1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- 2. This is the increase in supply current for each input at 3.4V.
- 3. For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
- This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V ± 10%, a transition time of up to 100µsec is permitted.

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899

AC CHARACTERISTICS

GND = 0V; t_R = t_F = 2.5ns; C_L = 50pF, R_L = 500 $\!\Omega$

					LIMITS			
SYMBOL	PARAMETER	WAVEFORM	٦	$F_{amb} = +25^{\circ}$ $V_{CC} = +5.0$ $C_L = 50pF$ $R_L = 500\Omega$	/	T _{amb} = -4 V _{CC} = +5 C _L = R _L =	UNIT	
			Min	Тур	Max	Min	Max	
t _{PLH} t _{PHL}	Propagation delay An to Bn or Bn to An	1	1.0 1.0	3.2 2.7	4.5 4.1	1.0 1.0	4.9 4.6	ns
t _{PLH} t _{PHL}	Propagation delay An to BPAR or Bn to APAR	2	3.0 2.5	6.0 6.4	7.5 7.9	3.0 2.5	9.0 8.8	ns
t _{PLH} t _{PHL}	Propagation delay An to ERRA or Bn to ERRB	3	2.8 2.8	6.0 6.7	8.0 8.5	2.8 2.8	9.1 9.3	ns
t _{PLH} t _{PHL}	Propagation delay APAR to BPAR or BPAR to APAR	1	2.0 1.3	4.0 3.2	5.2 4.4	2.0 1.3	5.7 5.0	ns
t _{PLH} t _{PHL}	Propagation delay APAR to ERRA or BPAR to ERRB	6	1.5 1.5	4.2 4.0	5.4 5.4	1.5 1.5	6.0 6.1	ns
t _{PLH} t _{PHL}	Propagation delay ODD/EVEN to APAR or BPAR	5	2.6 2.5	5.5 5.3	6.8 6.7	2.6 2.5	8.1 7.8	ns
t _{PLH} t _{PHL}	Propagation delay ODD/EVEN to ERRA or ERRB	4	2.3 2.6	5.4 5.7	6.8 7.2	2.3 2.6	7.9 8.4	ns
t _{PLH} t _{PHL}	Propagation delay SEL to APAR or BPAR	8	1.3 1.4	4.1 4.1	5.2 5.3	1.3 1.4	6.0 5.9	ns
t _{PLH} t _{PHL}	Propagation delay SEL to ERRA or ERRB	8	3.7 5.1	6.8 8.3	8.3 9.7	3.7 5.1	9.8 11.0	ns
t _{PLH} t _{PHL}	Propagation delay LEA to Bn or LEB to An	9	1.0 1.0	3.2 3.1	4.4 4.5	1.0 1.0	4.9 5.0	ns
t _{PLH} t _{PHL}	Propagation delay LEA to BPAR or LEB to APAR	9	2.0 1.7	6.8 6.3	8.3 7.9	2.0 1.7	9.7 9.0	ns
t _{PLH} t _{PHL}	Propagation delay LEA to ERRA or LEB to ERRB	7	2.0 2.0	6.3 7.1	8.3 9.2	2.0 2.0	9.6 10.3	ns
t _{PZH} t _{PZL}	Output enable time OEA to An, APAR or OEB to Bn, BPAR	11, 12	1.0 1.0	3.0 3.4	4.3 4.8	1.0 1.0	5.1 5.4	ns
t _{PHZ}	Output disable time OEA to An, APAR or OEB to Bn, BPAR	11, 12	1.0 0.5	3.4 3.0	4.7 4.2	1.0 0.5	5.5 4.7	ns

AC SETUP REQUIREMENTS

GND = 0V; $t_B = t_F = 2.5 \text{ns}$; $C_L = 50 \text{pF}$, $R_L = 500 \Omega$

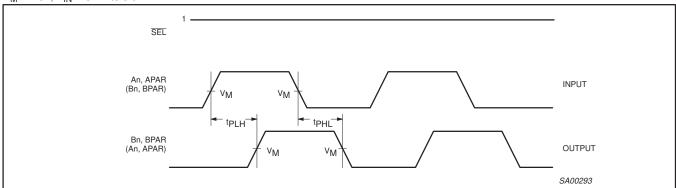
SYMBOL	PARAMETER	$ \begin{array}{c} T_{amb} = +25^{\circ}C & T_{amb} = -40 \text{ tr} \\ V_{CC} = +5.0V & V_{CC} = +5.0V \\ C_{L} = 50 \text{pF} & C_{L} = 50 \\ R_{L} = 500 \Omega & R_{L} = 50 \end{array} $					50pF	UNIT
			Min	Тур	Max	Min	Max	
t _s (H) t _s (L)	Setup time, High or Low An, APAR to LEA or Bn, BPAR to LEB	10	2.0 1.5	0.4 0.0		2.0 1.5		ns
t _h (H) t _h (L)	Hold time, High or Low An, APAR to LEA or Bn, BPAR to LEB	10	1.5 1.0	0.0 -0.2		1.5 1.0		ns
t _w (H)	Pulse width, High LEA or LEB	10	3.0	1.9		3.0		ns

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

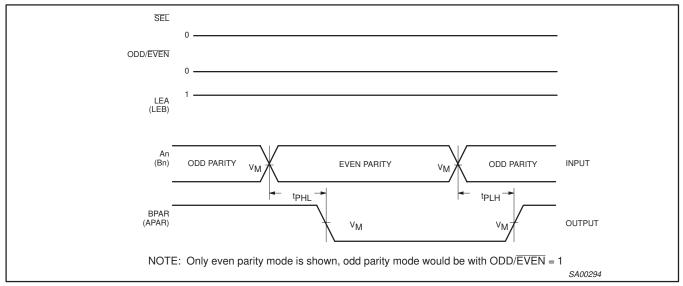
74ABT899

AC WAVEFORMS

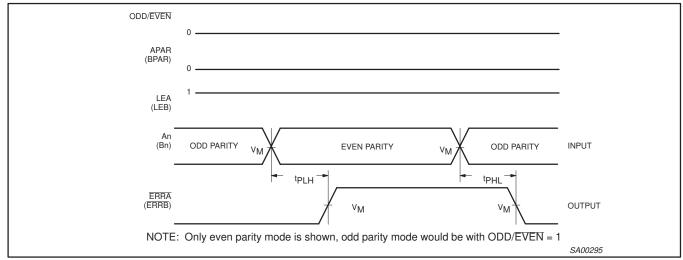
 $V_M = 1.5V$, $V_{IN} = GND$ to 3.0V



Waveform 1. Propagation Delay, An to Bn, Bn to An, APAR to BPAR, BPAR to APAR



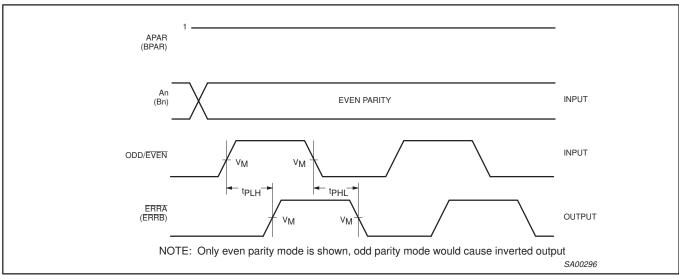
Waveform 2. Propagation Delay, An to BPAR or Bn to APAR



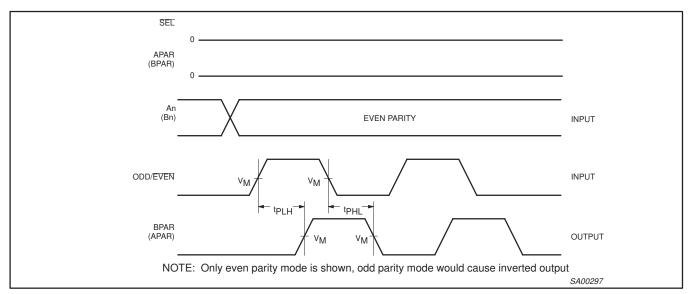
Waveform 3. Propagation Delay, An to ERRA or Bn to ERRB

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899



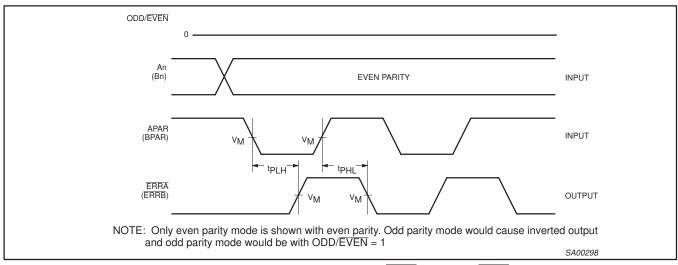
Waveform 4. Propagation Delay, ODD/EVEN to ERRA or ODD/EVEN to ERRB



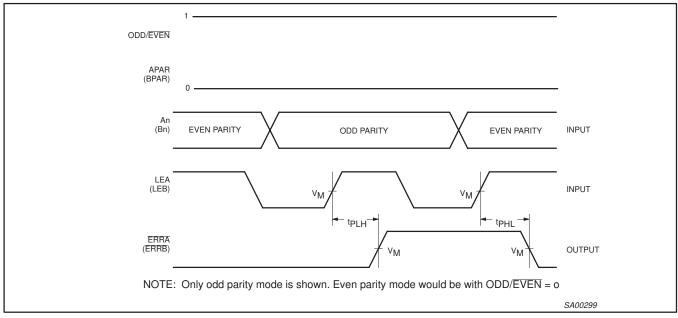
Waveform 5. Propagation Delay, ODD/EVEN to APAR or ODD/EVEN to BPAR

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899



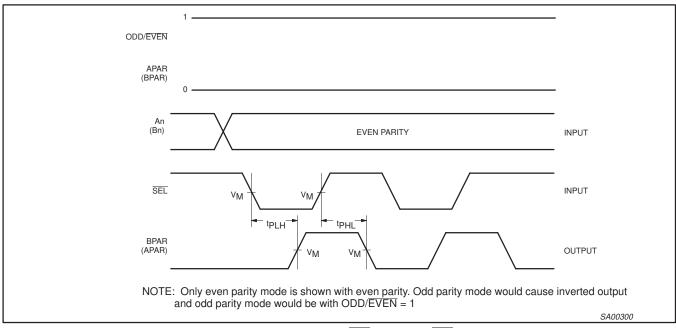
Waveform 6. Propagation Delay, APAR to ERRA or BPAR to ERRB



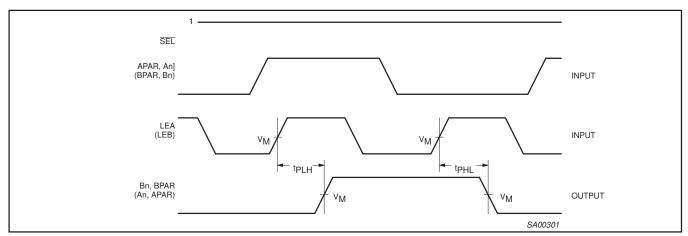
Waveform 7. Propagation Delay, LEA to ERRA or LEB to ERRB

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

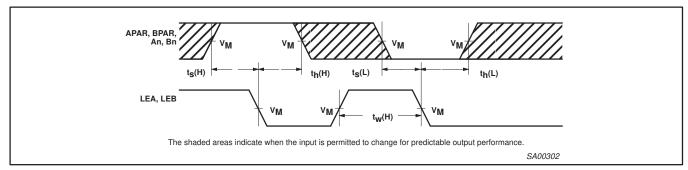
74ABT899



Waveform 8. Propagation Delay, SEL to BPAR or SEL to APAR



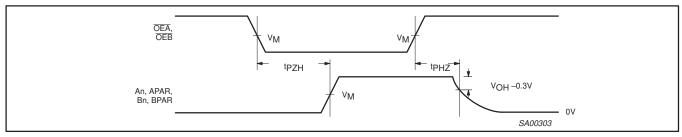
Waveform 9. Propagation Delay, LEA to BPAR or LEB to APAR, LEA to Bn or LEB to An



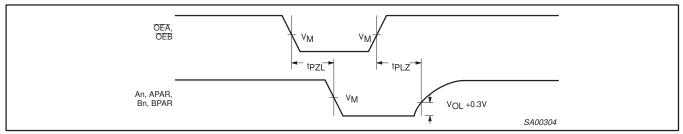
Waveform 10. Data Setup and Hold Times, Pulse Width High

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899

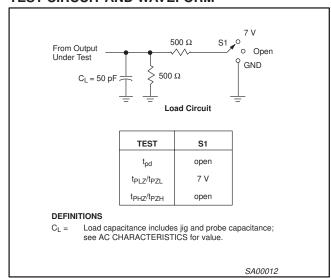


Waveform 11. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 12. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

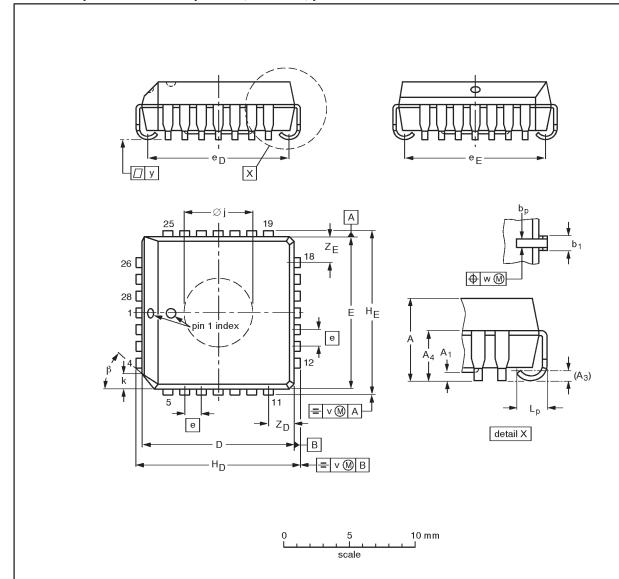
TEST CIRCUIT AND WAVEFORM



74ABT899

PLCC28: plastic leaded chip carrer; 28 leads; pedestal

SOT261-3



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	А	A ₁ min.	A ₃	A ₄ max.	bp	b ₁	D ⁽¹⁾	E ⁽¹⁾	е	еD	еE	H _D	HE	k	øj	Lp	v	w	у	Z _D ⁽¹⁾ max.	Z _E ⁽¹⁾ max.	β
mm	4.57 4.19	0.13	0.25	3.05	0.53 0.33	0.81 0.66	11.58 11.43	11.58 11.43		10.92 9.91			12.57 12.32	1.22 1.07	5.69 5.54	1.44 1.02	0.18	0.18	0.10	2.06	2.06	45°
inches	0.180 0.165	0.005	0.01	0.12		0.032 0.026				0.430 0.390			0.495 0.485				0.007	0.007	0.004	0.081	0.081	40

Note

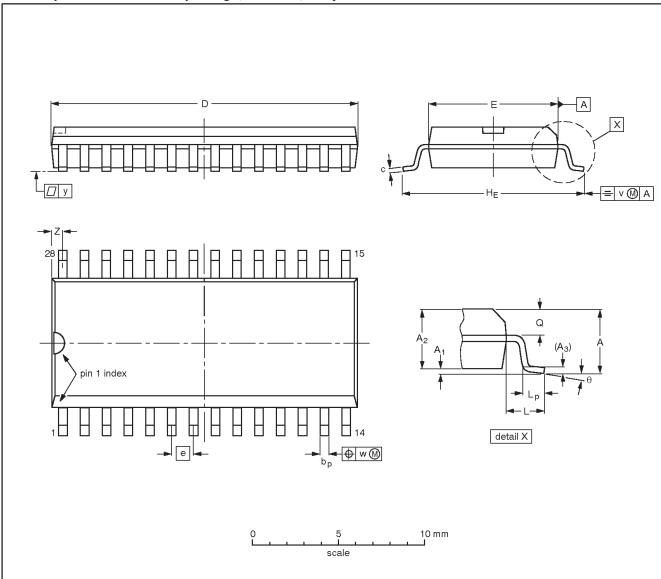
1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT261-3		MO-047AB				95-02-25 97-12-16

74ABT899

SO28: plastic small outline package; 28 leads; body width 7.5mm

SOT136-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	А3	bр	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	18.1 17.7	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.71 0.69	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

Note

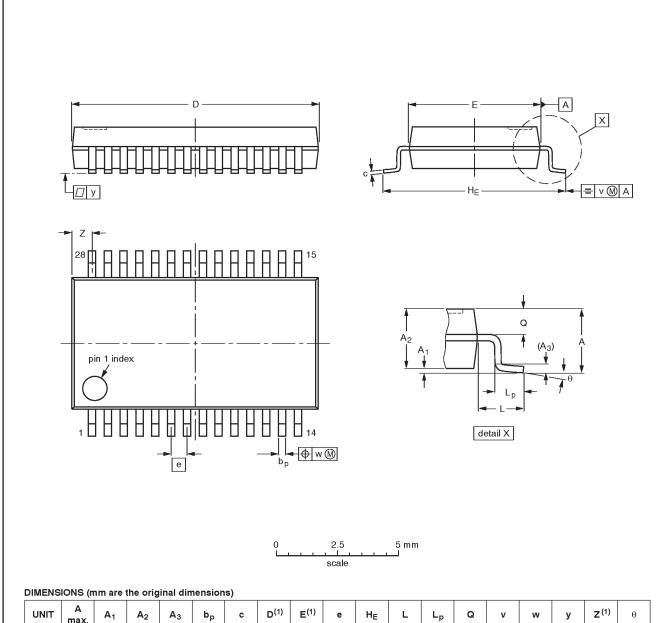
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT136-1	075E06	MS-013AE				-95-01-24 97-05-22

74ABT899

SSOP28: plastic shrink small outline package; 28 leads; body width 5.3mm

SOT341-1



UNIT	A max.	A ₁	A ₂	Α3	bp	c	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	10.4 10.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.1 0.7	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT341-1		MO-150AH			93-09-08 95-02-04

9-bit dual latch transceiver with 8-bit parity generator/checker (3-State)

74ABT899

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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